# INTERNATIONAL STANDARD



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# Identification cards — Contactless integrated circuit(s) cards — Vicinity cards —

Part 1: **Physical characteristics** 

iTeh STANDARD PREVIEW Cartes d'identification — Cartes à circuit(s) intégré(s) sans contact — Cartes de voisinage — eh.ai

Partie 1: Caractéristiques physiques ISO/IEC 15693-1:2000 https://standards.iteh.ai/catalog/standards/sist/8785990d-741c-46a1-89ee-9cf4d6296d96/iso-iec-15693-1-2000



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## Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work.

International Standards are drafted in accordance with the rules given in the ISO/IEC Directives, Part 3.

In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1. Draft International Standards adopted by the joint technical committee are circulated to national bodies for voting. Publication as an International Standard requires approval by at least 75 % of the national bodies casting a vote.

Attention is drawn to the possibility that some of the elements of this part of ISO/IEC 15693 may be the subject of patent rights. ISO and IEC shall not be held responsible for identifying any or all such patent rights.

International Standard ISO/IEC 15693-1 was prepared by Joint Technical Committee ISO/IEC JTC 1, *Information technology*, Subcommittee SC 17, *Identification cards and related devices*.

ISO/IEC 15693 consists of the following parts, under the general title *Identification cards* — *Contactless integrated circuit(s) cards* — *Vicinity cards*: **(standards.iteh.ai)** 

— Part 1: Physical characteristics

ISO/IEC 15693-1:2000

- Part 2: Air interface and initializations.iteh.ai/catalog/standards/sist/8785990d-741c-46a1-89ee-

9cf4d6296d96/iso-iec-15693-1-2000

- Part 3: Anticollision and transmission protocols
- Part 4: Extended command set and security features

Annexes A, B and C of this part of ISO/IEC 15693 are for information only.

## Introduction

ISO/IEC 15693 is one of a series of International Standards describing the parameters for identification cards as defined in ISO/IEC 7810 and the use of such cards for international interchange.

This part of ISO/IEC 15693 describes the physical characteristics of vicinity cards.

This part of ISO/IEC 15693 does not preclude the incorporation of other standard technologies on the card, such as those referenced in the informative annex A.

Contactless Card Standards cover a variety of types as embodied in ISO/IEC 10536 (Close-coupled cards), ISO/IEC 14443 (Proximity cards), ISO/IEC 15693 (Vicinity cards). These are intended for operation when very near, nearby and at a longer distance from associated coupling devices respectively.

ISO/IEC 15693 is intended to allow operation of Vicinity cards in the presence of other contactless cards conforming to ISO/IEC 10536 and ISO/IEC 14443 standards.

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# Identification cards — Contactless integrated circuit(s) cards — Vicinity cards — Part 1: Physical characteristics

#### 1 Scope

This part of ISO/IEC 15693 specifies the physical characteristics of vicinity cards (VICC). It applies to identification cards of the card type ID-1 operating in vicinity of a coupling device.

This part of ISO/IEC 15693 shall be used in conjunction with later parts of ISO/IEC 15693.

#### 2 Normative references

The following normative documents contain provisions which, through reference in this text, constitute provisions of this part of ISO/IEC 15693. For dated references, subsequent amendments to, or revisions of, any of these publications do not apply. However, parties to agreements based on this part of ISO/IEC 15693 are encouraged to investigate the possibility of applying the most recent editions of the normative documents indicated below. For undated references, the latest edition of the normative document referred to applies. Members of ISO and IEC maintain registers of currently valid International Standards. Iteh.al

ISO/IEC 7810, Identification cards - Physical characteristics.

ISO/IEC 10373, Identification cards and Test methods and and sist/8785990d-741c-46a1-89ee-

9cf4d6296d96/iso-iec-15693-1-2000

IEC 61000-4-2, Electromagnetic compatibility (EMC) - Part 4: Testing and measurement techniques - Section 2: Electrostatic discharge immunity test.

### 3 Terms and definitions

For the purposes of this part of ISO/IEC 15693, the following terms and definitions apply.

#### 3.1

#### integrated circuit(s) (IC)

Electronic component(s) designed to perform processing and/or memory functions.

#### 3.2

#### contactless

Pertaining to the achievement of signal exchange with and supplying power to the card without the use of galvanic elements (i.e., the absence of an ohmic path from the external interfacing equipment to the integrated circuit(s) contained within the card).

#### 3.3

#### contactless integrated circuit(s) card

A card of the card type ID-1 (as specified in ISO/IEC 7810) into which integrated circuit(s) have been placed and in which communication to such integrated circuit(s) is done in a contactless manner.

#### 3.4

#### vicinity card (VICC)

A card of the card type ID-1 into which integrated circuit(s) and coupling means have been placed and in which communication to such integrated circuit(s) is done by inductive coupling in vicinity of a coupling device.

#### 3.5

#### vicinity coupling device (VCD)

The reader/writer device that uses inductive coupling to provide power to the VICC and also to control the data exchange with the VICC.

#### **4** Physical characteristics

#### 4.1 General

The VICC shall have physical characteristics according to the requirements for the card type ID-1 specified in ISO/IEC 7810.

#### 4.2 Dimensions

The nominal dimensions of the VICC shall be as for the card type ID-1 specified in ISO/IEC 7810.

#### 4.3 Additional characteristics

# 4.3.1 Ultra-violet light **iTeh STANDARD PREVIEW**

This part of the ISO/IEC 15693 excludes requirements for protection of the VICC against the effects of ultra-violet light levels greater than those in ordinary daylight at sea-level. Where greater protection is needed it shall be the responsibility of the card manufacturer to provide it and to state the tolerable level of ultra-violet light.

**4.3.2 X-rays** https://standards.iteh.ai/catalog/standards/sist/8785990d-741c-46a1-89ee-9cf4d6296d96/iso-iec-15693-1-2000

The VICC shall continue to operate as intended after exposure of either face to medium-energy X-radiation, with energy in the range of 70 keV to 140 keV, of a cumulative dose of 0,1 Gy per year.

NOTE This corresponds to approximately twice the maximum acceptable dose to which humans may be exposed annually.

#### 4.3.3 Dynamic bending stress

The VICC shall continue to operate as intended after testing in accordance with the test methods described in ISO/IEC 10373 where the maximum deflections about the short and long cards axes are  $h_wA = 20$  mm and  $h_wB = 10$  mm.

#### 4.3.4 Dynamic torsional stress

The VICC shall continue to operate as intended after testing in accordance with the test methods described in ISO/IEC 10373 where the maximum angle of rotation is  $\alpha = 15^{\circ}$ .

#### 4.3.5 Alternating magnetic fields

The VICC shall continue to operate as intended after exposure, in any orientation, to a magnetic field with an average level given in the Table 1. The averaging time is 6 minutes and the maximum rms level of the magnetic field is limited to 33 times the average level.

Frequency Range (MHz)	Average Magnetic Field Strength (A/m rms)
0,3 - 3,0	1,63
3,0 - 30	4,89/f
30 - 300	0,163

#### Table 1 — Magnetic Field Strength vs Frequency

f: frequency in MHz

Additionally, the VICC shall continue to operate as intended after continuous exposure to a magnetic field of an average level of 10 A/m rms at 13,56 MHz. The averaging time is 30 seconds and the maximum level of the magnetic field is limited to 12 A/m rms.

#### 4.3.6 Alternating electric field

The VICC shall continue to operate as intended after exposure, in any orientation, to an electric field with an average level given in the Table 2. The averaging time is 6 minutes and the maximum rms level of the electric field is limited to 33 times the average level.

#### Table 2 — Electric Field Strength vs Frequency

Frequency Range (MHz)	Average Electric Field Strength (V/m rms)
iTeh S.T.3,0NDAI	RD PRE14 IEW
3,0-30	1842/f
30- <u>300</u> -1300	<b>5.11011.2</b> 61,4

#### *f*: frequency in MHZIEC 15693-1:2000

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## 4.3.7 Static electricity

The VICC shall continue to operate as intended after testing in accordance with the test methods described in ISO/IEC 10373 (referring to IEC 61000-4-2:1995), where the test voltage is 6 kV.

#### 4.3.8 Static magnetic field

The VICC shall continue to operate as intended after exposure to a static 640 kA/m magnetic field.

WARNING — The data content of a magnetic stripe might be erased by such a field.

#### 4.3.9 Operating temperature

The VICC shall operate as intended over an ambient temperature range of 0 °C to 50 °C.